



## Materials Declaration Form

<b>IPC Form Type *</b>	1752 Distribute	<b>Version</b>	2
<b>Sectionals *</b>	Material Info Manufacturing Info	<b>Subsectionals *</b>	A-D
<i>* : Required Field</i>			

Supplier Information			
<b>Company Name *</b>	STMicroelectronics	<b>Response Date *</b>	2015-09-18
<b>Contact Name *</b>	Refer to Supplier Comment section		Refer to Supplier Comment section
<b>Authorized Representative *</b>	Rossana Bonaccorso	<b>Representative Title</b>	IPD MD Champion
<b>Representative Phone *</b>	Refer to Supplier Comment section	<b>Representative Email *</b>	Refer to Supplier Comment section
<b>Supplier Comment</b>	Online Technical Support - STMicroelectronics : <a href="http://www.st.com/web/en/support/support.html">http://www.st.com/web/en/support/support.html</a>		

**Uncertainty Statement**

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Legal Statement			
<b>Supplier Acceptance *</b>	true	<b>Legal Declaration *</b>	Standard
<b>Legal Statement</b>	<p>Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.</p>		

Product				
Mfr Item Number	Mfr Item Name	Version	Mfr Site	Date
SMTPA240	8HZG*CWB240M	A	BOUSKOURA B/E	2015-09-18
Amount		UoM	Unit type	ST ECOPACK Grade
98.00		mg	Each	ECOPACK2

Manufacturing information				
J-STD-020 MSL Rating	Classification Temp	Nbr of Reflow Cycles		
1	260	3		
bulk Solder Termination	Terminal Plating	Terminal Base Alloy	Comment	
NAC	Tin (Sn), matte	Copper Alloy		



Package Designator	Size	Nbr of instances	Shape	
SOJ	4.2, 3.7, 2.37	2	J BEND	
Comment	SMB CLIP (SOD 6)			

QueryList : ROHS directive 2011/65/EU _ July 2011	
Query	Response
1 - Product(s) meets EU RoHS requirement without any exemptions	false
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)	false
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)	true
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions	false
5 - Product(s) is obsolete, no information is available	false
6 - Product(s) is unknown, no information is available	false
Exemption Id.	Description
7a	Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)

QueryList : REACH-15th June 2015				
Query				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product

Material Composition Declaration						Mfr Item Name	8HZG*CW8240M					
Homogeneous Material	Material Group	Mass	UoM	Level	Substance Category	Substance	CAS	Exempt	Mass	UoM	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die or Dies (choose)	Other inorganic materials	1.029	mg	supplier	die	Silicon (Si)	7440-21-3		1.005	mg	976654	10245
				supplier	metallization	Aluminium (Al)	7429-90-5		0.004	mg	3891	41
				supplier	Passivation	Silicon Oxide	7631-86-9		0.005	mg	4864	51
				supplier	back side metallization	Aluminium (Al)	7429-90-5		0.005	mg	4864	51
				supplier	back side metallization	Gold (Au)	7440-57-5		0.002	mg	1946	20
				supplier	back side metallization	Nickel (Ni)	7440-02-0		0.008	mg	7782	82
Leadframe	Copper & its alloys	40.676	mg	supplier	alloy	Copper (Cu)	7440-50-8		40.623	mg	998697	414520
				supplier	alloy	Iron (Fe)	7439-89-6		0.041	mg	1008	418
				supplier	alloy	Iron Phosphide (FeP)	26508-33-8		0.012	mg	295	122
Soft solder	Solder	1.239	mg	JIG - R	solder	Lead (Pb)	7439-92-1	7a-Lead in high me	1.158	mg	934625	11816
				supplier	solder	Tin (Sn)	7440-31-5		0.062	mg	50040	633
				supplier	solder	Silver (Ag)	7440-22-4		0.019	mg	15335	194
Encapsulation	Other Organic Materials	35.915	mg	supplier	mold compound	Silica, vitreous	60676-86-0		27.296	mg	760017	278531
				supplier	mold compound	Epoxy Cresol Novolak	29690-82-2		3.663	mg	101991	37378
				supplier	mold compound	Phenol resin	9003-35-4		2.155	mg	60003	21990
				supplier	mold compound	Others	Proprietary		1.796	mg	50007	18327
				supplier	mold compound	Metal hydroxide	Proprietary		0.718	mg	19992	7327
				supplier	mold compound	Carbon black	1333-86-4		0.287	mg	7991	2929
Connections coating	Solder	0.811	mg	supplier	solder alloy	Tin (Sn)	7440-31-5		0.811	mg	1000000	8276
Clip	Copper & its alloys	18.330	mg	supplier	alloy	Copper (Cu)	7440-50-8		18.330	mg	1000000	187041